DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

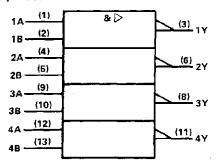
These devices contain four independent 2-input NAND buffer gates.

The SN5437, SN54LS37 and SN54S37 are characterized for operation over the full military range of $-55\,^{\circ}\text{C}$ to $125\,^{\circ}\text{C}$. The SN7437, SN74LS37 and SN74S37 are characterized for operation from $0\,^{\circ}\text{C}$ to $70\,^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
<u>A</u> _	₿	Y
Н	Н	L
L	×	н
x	L	Н

logic symbol†



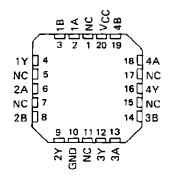
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5437, SN54LS37, SN54S37... J OR W PACKAGE SN7437... N PACKAGE SN74LS37, SN74S37... D OR N PACKAGE (TOP VIEW)

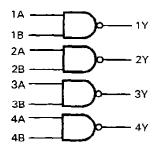
	
1A □1	U14¤Vcc
1B □2	13∏4B
17 □3	12 🗖 4A
2A 🗖 4	11 4Y
2₿ 🏻 5	10 □ 3B
2Y 🛮 6	9∐3A
GND 🗆 7	8 3Y

SN54LS37, SN54S37...FK PACKAGE (TOP VIEW)



NC - No internal connection

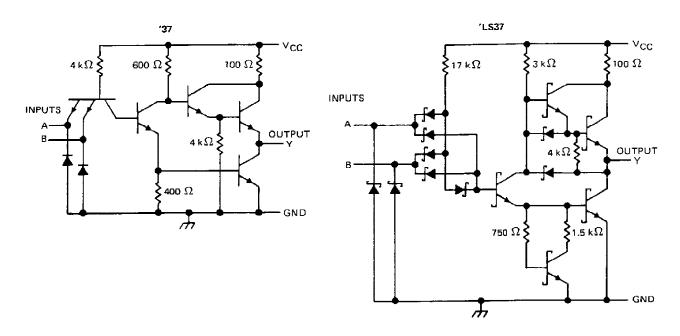
logic diagram

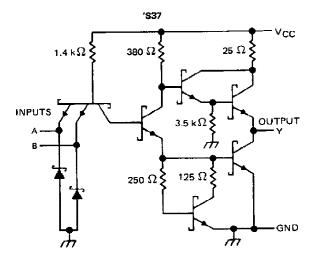


positive logic

 $Y = \overline{A \cdot B} \text{ or } Y = \overline{A} + \overline{B}$

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, Voc (see Note	1)	7 V
Input voltage: '37, 'S37		5.5 V
1 S37		7 V
Operating free-air temperature:	SN54'5	55°C to 125°C
Sporacing mos an isomporacing	SN74'	. 0°C to 70°C
Charana tamparatura ranga		35°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



recommended operating conditions

			SN5437			SN7437			
		MIN	NOM	MAX	MIN	MOM	MAX	UNIT	
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
ViH	High-level input voltage	2			2			V	
VIL	Low-level input voltage		-	8.0			0.8	V	
ТОН	High-level output current			- 1.2			- 1.2	mΑ	
loL	Low-level output current			48			48	mΑ	
ŤA	Operating free-air temperature	- 55		125	0		70	э <mark>С</mark>	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	IONS †		SN5437			SN7437	,	UNIT
PARAMETER		TEST COMBITTONS !			TYP#	MAX	MIN	TYP \$	MAX	UNII
VIK	V _{CC} ≈ MIN,	I _I = - 12 mA		<u> </u>		1.5			- 1.5	٧
νон	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 1.2 mA	2.4	3.3		2.4	3.3		V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 48 mA		0.2	0.4		0.2	0.4	V
11	V _{CC} = MAX,	V ₁ = 6.5 V				1			1	mA
Iн	V _{CC} = MAX,	V = 2.4 V				40		_	40	μА
ΊΙL	VCC = MAX,	V _I = 0.4 V				- 1.6			- 1.6	mA
I _{OS} §	V _{CC} = MAX			20		- 70	- 18		- 70	mA
Гссн	V _{CC} ≈ MAX,	V ₁ = 0 V			9	15.5		9	15.5	mΑ
ICCL	$V_{CC} = MAX$,	V ₁ = 4.5 V			34	54		34	54	mΑ

- † For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
- ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{\Delta} = 25^{\circ}\text{C}$.
 § Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
tPLH	A or B		R ₁ = 133 Ω,	C. = 45 pc		13	22	กร
tPHL	Aora	,	n[- 133 11,	C _L = 45 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS37, SN74LS37 QUADRUPLE 2-INPUT POSITIVE-NAND BUFFERS

recommended operating conditions

		S	\$N54L\$37			SN74LS37			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2	-		$\overline{}$	
VIL	Low-level input voltage			0.7			8.0	V	
Гон	High-level output current			-1.2			- 1.2	mA	
loL	Low-level output current			12		-	24	mA	
TA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	TIONS T	8	N54LS	37	5	UNIT		
FARANIETER		TEST CONDIT	101131	MIN	TYP‡	MAX	MIN	TYP#	MAX	UNIT
VIK	V _{CC} = MIN,	I _I = -18 mA			_	- 1.5			- 1.5	٧
Voн	V _{CC} = MIN,	V _{IL} = MAX,	I _{OH} = - 1.2 mA	2.5	3.4		2.7	3.4		٧
Va	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	· V
V _{OL}	VCC = MIN.	V _{JH} = 2 V	10L = 24 mA					0.35	0.5	· ·
<u> 11</u>	V _{CC} = MAX,	V _I = 7 V		1 -		0.1			0.1	mA
ЧΗ	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μΑ
ΙĮL	V _{CC} = MAX.	V _I = 0.4 V		_		-0.4			- 0.4	mA
1 _{OS} §	V _{CC} = MAX			- 30		130	- 30		- 130	mA
Іссн	V _{CC} = MAX,	V ₁ = 0 V		1	0.9	2		0.9	2	mA
ICCL	V _{CC} = MAX,	V _I = 4.5 V			6	12		6	12	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
₹PLH	A or B	~	$R_1 = 667 \Omega$,	C. = 45 nE		12	24	ns
tPH∟	40.6		R _L = 667 Ω,	C _L = 45 pF		12	24	กร

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

recommended operating conditions

		SN54S37		[;	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	01411
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage	2			2			V
VIL Low-level input voltage			8.0			8.0	V
IOH High-level output current			– 3			- 3	mA
IOL Low-level output current			60			60	mA
TA Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN54S3	7		7		
PARAMETER		TEST CONDITIONS †	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT	
VIK	V _{CC} = MIN,	lı = — 18 mA			•	- 1.2			- 1.2	V
VoH	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 3 mA	2.5	3.4		2.7	3.4		V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	IQL = 60 mA			0.5			0.5	V
11	VCC = MAX.	V _I = 5.5 V				1			1	mΑ
ΊΗ	V _{CC} = MAX,	V ₁ = 2.7 V				0.1			0.1	mΑ
IIL	V _{CC} = MAX,	V _I = 0.5 V			-	- 4			- 4	mA
IOS §	V _{CC} = MAX			50		- 225	- 50		- 225	mA
ГССН		V ₁ - 0 V	·		20	36		20	36	mA
CCL	V _{CC} = MAX,	V _I = 4.5			46	80		46	80	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed 100 milliseconds.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN TYP	MAX	UNIT	
t _{PLH}			R _L = 93 Ω,	C _L = 50 pF	4	6.5 6.5	ns
tPLH_	A or B	Υ .	R _L = 93 Ω,	C ₁ = 150 pF	6		กร
t _{PHL}					6		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins	-	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
5962-9754101Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK	Samples
5962-9754101QCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J	Samples
5962-9754101QCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J	Samples
5962-9754101QDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W	Samples
5962-9754101QDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W	Samples
SN54LS37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS37J	Samples
SN54LS37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS37J	Samples
SN54S37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54S37J	Samples
SN54S37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54S37J	Samples
SN74LS37N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS37N	Samples
SN74LS37N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS37N	Samples
SN74LS37NSR	ACTIVE	so	NS	14	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37	Samples
SN74LS37NSR	ACTIVE	so	NS	14	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37	Samples
SN74S37D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37	Samples
SN74S37D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37	Samples





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S37N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74S37N	Samples
SN74S37N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74S37N	Samples
SNJ54LS37FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK	Sample
SNJ54LS37FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK	Samples
SNJ54LS37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J	Samples
SNJ54LS37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J	Samples
SNJ54LS37W	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W	Samples
SNJ54LS37W	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W	Samples
SNJ54S37FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 37FK	Samples
SNJ54S37FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 37FK	Samples
SNJ54S37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S37J	Sample
SNJ54S37J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S37J	Samples
SNJ54S37W	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S37W	Sample
SNJ54S37W	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S37W	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

PACKAGE OPTION ADDENDUM



6-Feb-2020

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS37, SN54S37, SN74LS37, SN74S37:

Catalog: SN74LS37, SN74S37

Military: SN54LS37, SN54S37

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product



PACKAGE OPTION ADDENDUM

6-Feb-2020

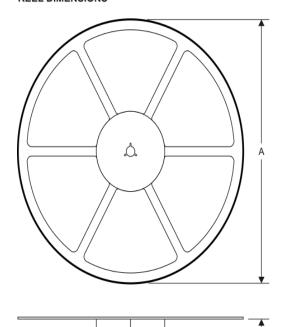
• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

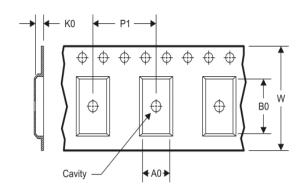
www.ti.com 14-Jul-2012

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS37NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 14-Jul-2012

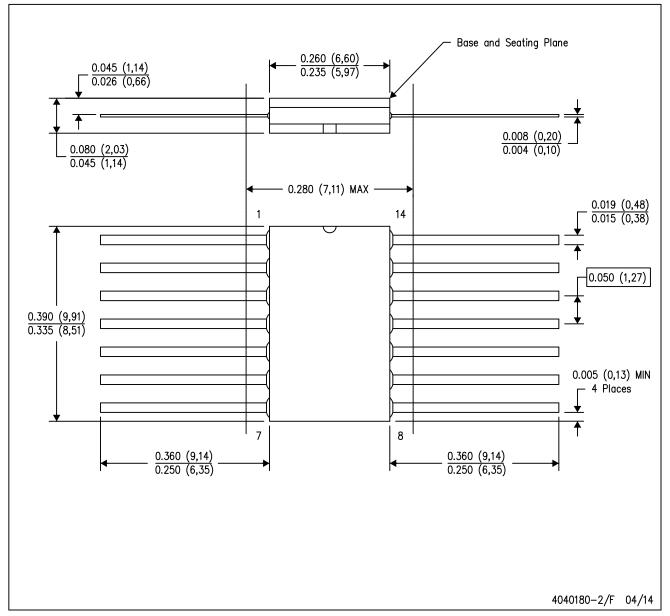


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74LS37NSR	SO	NS	14	2000	367.0	367.0	38.0	

W (R-GDFP-F14)

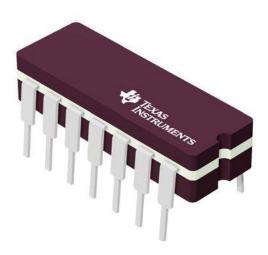
CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



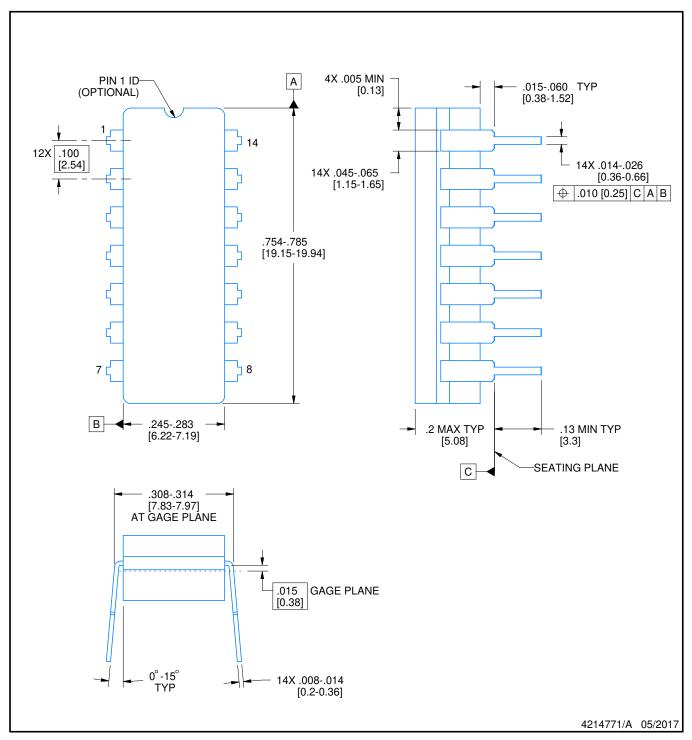
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





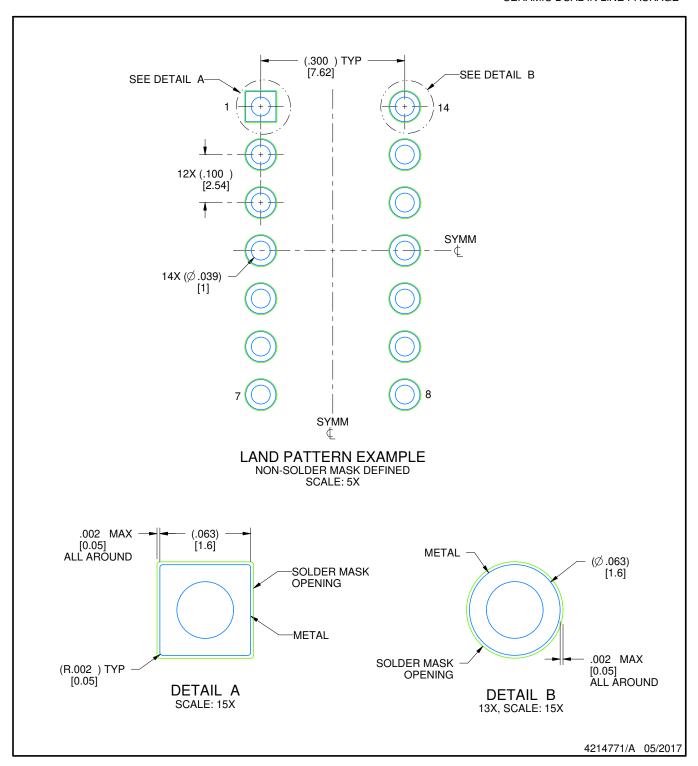
CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a certain is using glass int.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



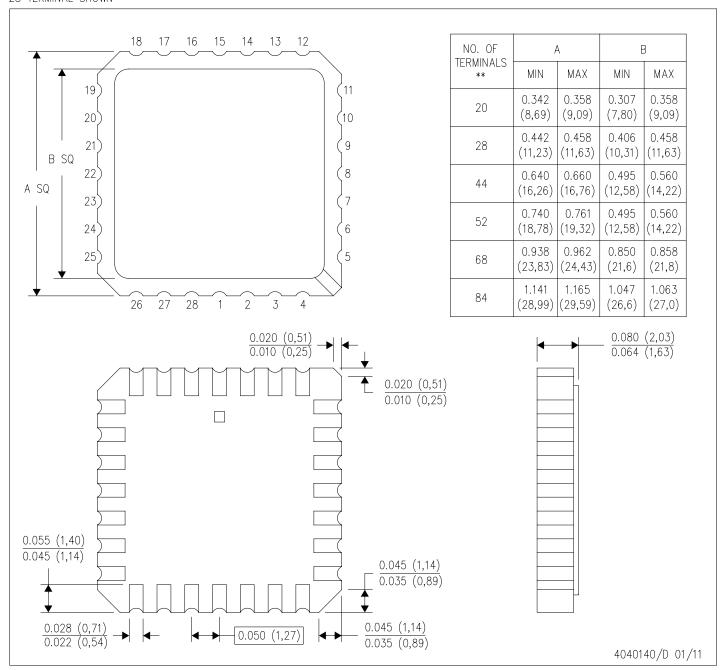
CERAMIC DUAL IN LINE PACKAGE



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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